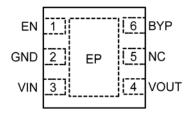
# **Ordering Information**

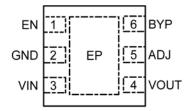
Part Number	Marking <sup>(1)</sup>	Voltage <sup>(2)</sup> (V)	Junction Temperature Range	Package	Lead Finish
MIC5319-1.3HYML	 13H	1.375	-40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319-1.8YML	918	1.8	-40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319-1.85YML	91J	1.85	-40°C to +125°C	6-Pin 2mm × 2mm MLF®	Pb-Free
MIC5319-2.5YML	925	2.5	-40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319-2.6YML	926	2.6	-40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319-2.7YML	927	2.7	−40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319-2.8YML	928	2.8	−40°C to +125°C	6-Pin 2mm × 2mm MLF®	Pb-Free
MIC5319-2.85YML	92J	2.85	−40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319-2.9YML	929	2.9	−40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319-3.0YML	930	3.0	−40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319-3.3YML	933	3.3	−40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319-5.0YML	950	5.0	-40°C to +125°C	6-Pin 2mm × 2mm MLF <sup>®</sup>	Pb-Free
MIC5319YML	9AA	ADJ	-40°C to +125°C	6-Pin 2mm × 2mm MLF®	Pb-Free
MIC5319-1.3HYD5	<u>N1</u> 3H	1.375	-40°C to +125°C	Thin SOT-23-5	Pb-Free
MIC5319-1.8YD5	<u>N9</u> 18	1.8	-40°C to +125°C	Thin SOT-23-5	Pb-Free
MIC5319-1.85YD5	<u>N9</u> 1J	1.85	-40°C to +125°C	Thin SOT-23-5	Pb-Free
MIC5319-2.5YD5	<u>N9</u> 25	2.5	-40°C to +125°C	Thin SOT-23-5	Pb-Free
MIC5319-2.6YD5	<u>N9</u> 26	2.6	-40°C to +125°C	Thin SOT-23-5	Pb-Free
MIC5319-2.7YD5	<u>N9</u> 27	2.7	-40°C to +125°C	Thin SOT-23-5	Pb-Free
MIC5319-2.8YD5	<u>N9</u> 28	2.8	-40°C to +125°C	Thin SOT-23-5	Pb-Free
MIC5319-2.9YD5 <sup>(3)</sup>	<u>N9</u> 29	2.9	-40°C to +125°C	Thin SOT-23-5	Pb-Free
MIC5319-3.0YD5	<u>N9</u> 30	3.0	-40°C to +125°C	Thin SOT-23-5 Pb-Free	
MIC5319-3.3YD5	<u>N9</u> 33	3.3	-40°C to +125°C	Thin SOT-23-5	Pb-Free
MIC5319-5.0YD5	<u>N9</u> 50	5.0	-40°C to +125°C	Thin SOT-23-5	Pb-Free

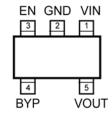
#### Notes:

- 1. Under-bar/Over-bar symbols may not be to scale.
- 2. For other output voltage options, contact Micrel Marketing.
- 3. Contact Micrel Marketing for availability.

# **Pin Configuration**







MIC5319 (Fixed) 6-Pin 2mm × 2mm MLF (ML) Top View

MIC5319 (Adjustable) 6-Pin 2mm × 2mm MLF (ML) Top View

MIC5319 (Adjustable) TSOT-23-5 (D5) Top View

## **Pin Description**

Pin Number MLF-6 Fixed	Pin Number MLF-6 Adjustable	Pin Number TSOT-23-5 Fixed	Pin Name	Pin Name
1	1	3	EN	Enable Input: Active High. High = ON, Low = OFF. Do not leave floating.
2	2	2	GND	Ground.
3	3	1	VIN	Supply Input.
4	4	5	VOUT	Output Voltage.
_	5	-	ADJ	Adjustable Input: Connect to external resistor voltage divider network.
5	_		NC	No connection for fixed voltage parts
6	6	4	ВҮР	Reference Bypass: Connect external 0.1µF to GND for reduced output noise. May be left open.
EP	EP	_	ePad	Exposed Heatsink Pad connected to ground internally

## **Absolute Maximum Ratings**(1)

0V to 6V
0V to 6V
Internally Limited (3)
40°C to +125°C
65°C to +150°C
260°C
3kV

# Operating Ratings<sup>(2)</sup>

Supply Input Voltage (V <sub>IN</sub> )	+2.5V to +5.5V
Enable Input Voltage (V <sub>EN</sub> )	0V to V <sub>IN</sub>
Junction Temperature (T <sub>J</sub> )	40°C to +125°C
Package Thermal Resistance	
MLF $(\theta_{JA})$	93°C/W
TSOT-23 (θ <sub>JA</sub> )	235°C/W

## Electrical Characteristics<sup>(5)</sup>

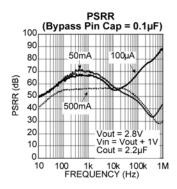
V<sub>IN</sub> = V<sub>OUT</sub> +1.0V; C<sub>OUT</sub> = 2.2μF; I<sub>OUT</sub> = 100μA; T<sub>J</sub> = 25°C, **bold** values indicate –40°C to +125°C, unless noted.

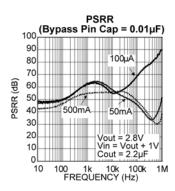
Parameter	Condition	Min.	Тур.	Max.	Units	
Output Voltage Accuracy	Variation from nominal V <sub>OUT</sub>	-1.0		+1.0	- %	
Output Voltage Accuracy	Variation from nominal V <sub>OUT</sub> , I <sub>OUT</sub> = 100mA to 500mA	-2.0		+2.0		
Feedback Voltage		1.2375	1.25	1.2625	V	
(ADJ Option)		1.225	1.25	1.275	]	
Line Regulation	$V_{IN} = V_{OUT} + 1V$ to 5.5V		0.04	0.3	%/V	
Load Regulation <sup>(6)</sup>	I <sub>OUT</sub> = 100μA to 500mA		0.1	0.5	%	
Dropout Voltage <sup>(7, 8)</sup>	I <sub>OUT</sub> = 50mA		20	40	mV	
Dropout Voltage	I <sub>OUT</sub> = 500mA		200	400		
Ground Pin Current <sup>(9)</sup>	I <sub>OUT</sub> = 0 to 500mA		90	150	μA	
Ground Pin Current in Shutdown	$V_{EN} \leq 0.2V$		0.5		μA	
Dinale Dejection	$f$ = up to 1kHz; $C_{OUT}$ = 2.2μF ceramic; $C_{BYP}$ = 0.1 μF		70		dD	
Ripple Rejection	$f$ = 10kHz; $C_{OUT}$ = 2.2μF ceramic; $C_{BYP}$ = 0.1 μF		60		dB	
Current Limit	V <sub>OUT</sub> = 0V	600	700		mA	
Output Voltage Noise	$C_{OUT} = 2.2 \mu F; C_{BYP} = 0.1 \mu F; 10 Hz to 100 kHz$		40		μVrms	
Turn-On Time	C <sub>OUT</sub> = 2.2μF; C <sub>BYP</sub> = 0.1 μF		40	100	μs	
Enable Input Voltage	Logic Low (Regulator Shutdown)			0.2	_ v	
	Logic High (Regulator Enabled)	1.2				
Enable Input Current	V <sub>IL</sub> = ≤ 0.2V (Regulator Shutdown)		0.01	1	μА	
Enable Input Current	V <sub>IH</sub> = ≥ 1.0V (Regulator Shutdown)		0.01	1		

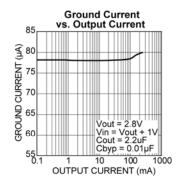
#### Notes:

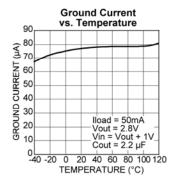
- 1. Exceeding the absolute maximum rating may damage the device.
- 2. The device is not guaranteed to function outside its operating rating.
- 3. The maximum allowable power dissipation of any  $T_A$  (ambient temperature) is  $P_D$  (max) =  $(T_{J(max)} T_A) / \theta_{JA}$ . Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator may go into thermal shutdown.
- 4. Devices are ESD sensitive. Handling precautions recommended. Human body model.
- 5. Specification for packaged product only.
- 6. Regulation is measured at constant junction temperature using low duty cycle pulse testing.
- Dropout voltage is defined as the input-to-output differential at which the output voltage drops 2% below its nominal V<sub>OUT</sub>. For outputs below 2.5V, dropout voltage spec does not apply, as part is limited by minimum V<sub>IN</sub> spec of 2.5V. There may be some typical dropout degradation at V<sub>OUT</sub> <3V.</li>
- 8. For ADJ option,  $V_{OUT} = 3V$  for dropout specification.
- Ground pin current is the regulator quiescent current. The total current drawn from the supply is the sum of the load current plus the ground pin current.

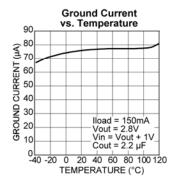
## **Typical Characteristics**

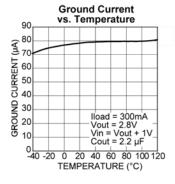


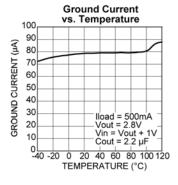


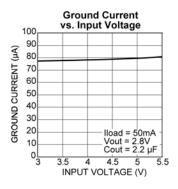


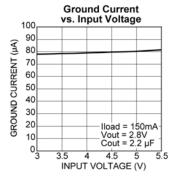


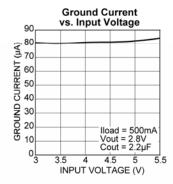


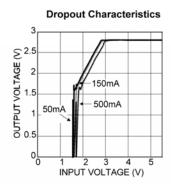


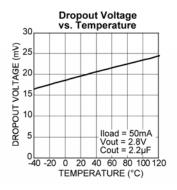




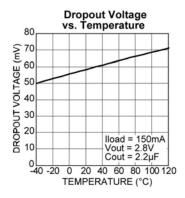


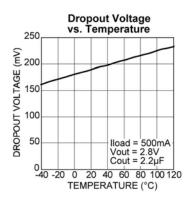


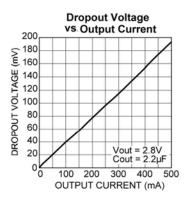


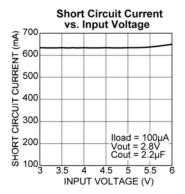


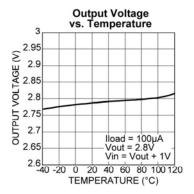
## **Typical Characteristics (Continued)**

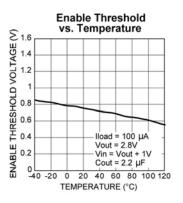


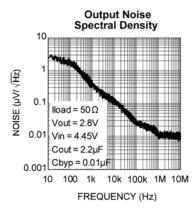




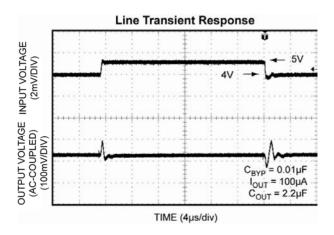


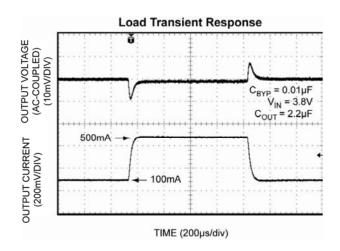


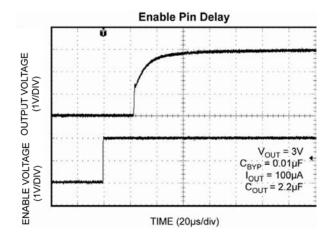


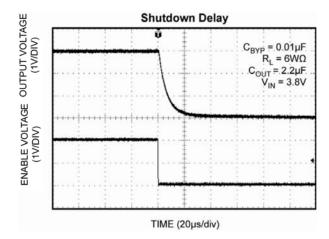


## **Functional Characteristics**

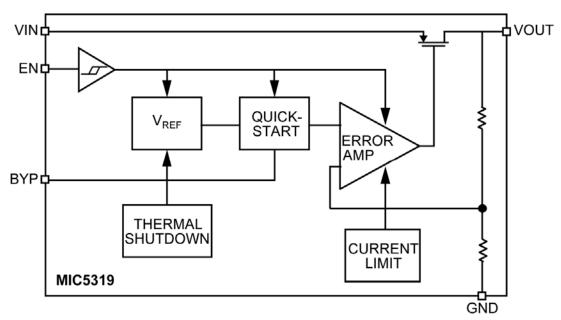




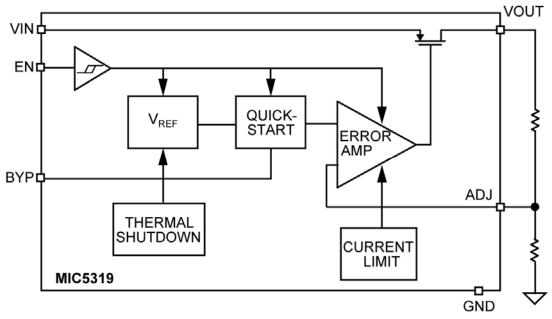




# **Functional Diagram**



MIC5319 Block Diagram - Fixed



MIC5319 Block Diagram - Adjustable

### **Applications Information**

#### Enable/Shutdown

The MIC5319 features an active-high enable pin that allows the regulator to be disabled. Forcing the enable pin low disables the regulator and sends it into a "zero" off-mode-current state. In this state, current consumed by the regulator goes nearly to zero. Forcing the enable pin high enables the output voltage. The active-high enable pin uses CMOS technology and the enable pin cannot be left floating, as this may cause an indeterminate state on the output.

#### **Input Capacitor**

The MIC5319 is a high-performance, high bandwidth device. Therefore, it requires a well-bypassed input supply for optimal performance. A 1µF capacitor is required from the input-to-ground to provide stability. Low-ESR ceramic capacitors provide optimal performance at a minimum of space. Additional high-frequency capacitors, such as small-valued NPO dielectric-type capacitors, help filter out high-frequency noise and are good design practice in any RF-based circuit.

#### **Output Capacitor**

The MIC5319 requires an output capacitor of  $2.2\mu F$  or greater to maintain stability. The design is optimized for use with low-ESR ceramic chip capacitors. High ESR capacitors may cause high-frequency oscillation. The output capacitor can be increased, but performance has been optimized for a  $2.2\mu F$  ceramic output capacitor and does not improve significantly with larger capacitance.

X7R/X5R dielectric-type ceramic capacitors temperature recommended because of their performance. X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

#### **Bypass Capacitor**

A capacitor can be placed from the bypass pin-to-ground to reduce output voltage noise. The capacitor bypasses the internal reference. A 0.1  $\mu F$  capacitor is recommended for applications that require low-noise outputs. The bypass capacitor can be increased, further reducing noise and improving PSRR. Turn-on time increases slightly with respect to bypass capacitance.

A unique, quick-start circuit allows the MIC5319 to drive a large capacitor on the bypass pin without significantly slowing turn-on time. Refer to the "Typical Characteristics" section for performance with different bypass capacitors.

#### **No-Load Stability**

Unlike many other voltage regulators, the MIC5319 will remain stable and in regulation with no load. This is especially important in CMOS RAM keep-alive applications.

#### Adjustable Regulator Application

Adjustable regulators use the ratio of two resistors to multiply the reference voltage to produce the desired output voltage.

The MIC5319 can be adjusted from 1.25V to 5.5V by using two external resistors (Figure 1). The resistors set the output voltage based on the following equation:

$$V_{OUT} = V_{REF} \left( 1 + \frac{R1}{R2} \right)$$

$$V_{REF} = 1.25V$$

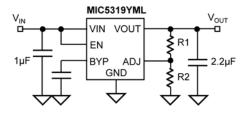


Figure 1. Adjustable Voltage Application

#### **Thermal Considerations**

The MIC5319 is designed to provide 500mA of continuous current in a very small MLF package. Maximum ambient operating temperature can be calculated based on the output current and the voltage drop across the part. Given an input voltage of 3.3V, output voltage of 2.8V and output current = 500mA, the actual power dissipation of the regulator circuit can be determined using the equation:

$$P_D = (V_{IN} - V_{OUT})I_{OUT} + V_{IN} \times I_{GND}$$

Because this device is CMOS and the ground current is typically <100 $\mu$ A over the load range, the power dissipation contributed by the ground current is <1% and can be ignored for this calculation:

$$P_D = (3.3V - 2.8V) \times 500mA$$

$$P_D = 0.25W$$

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation:

$$P_{D}(max) = \left(\frac{T_{J}(max) - T_{A}}{\theta_{JA}}\right)$$

 $T_J(max) = 125$ °C, the maximum junction temperature of the die.  $\theta_{JA}$  thermal resistance = 93°C/W.

Table 1 shows junction-to-ambient thermal resistance for the MIC5319 in the 2mm x 2mm MLF® package.

Package	θ <sub>JA</sub> Recommended Minimum Footprint	θ <sub>ЈС</sub>
2mm × 2mm MLF®	93°C/W	45°C/W
Thin SOT-23-5	235°C/W	

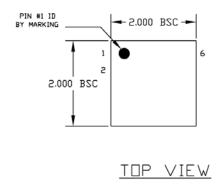
**Table 1. Thermal Resistance** 

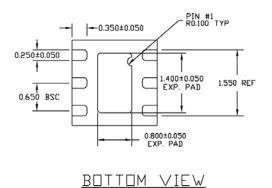
Substituting 0.25W for  $P_D(max)$  and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit. The maximum power dissipation must not be exceeded for proper operation.

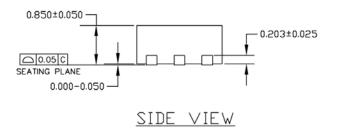
$$0.25W = \frac{125^{\circ}C - T_A}{93^{\circ}C/W}$$
$$T_A = 101.75^{\circ}C$$

Therefore, a 2.8V application at 500mA of output current can accept an ambient operating temperature of 101.75°C in a 2mm x 2mm MLF® package. For a full discussion of heat sinking and thermal effects on voltage regulators, refer to the "Regulator Thermals" section of Micrel's Designing with Low-Dropout Voltage Regulators handbook. This information can be found on Micrel's website at: <a href="https://www.micrel.com/">www.micrel.com/</a> PDF/other/LDOBk ds.pdf

## **Package Information**



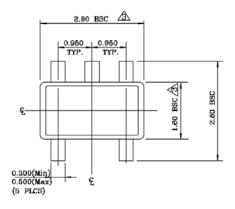




- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
  2. MAX. PACKAGE WARPAGE IS 0.05 mm.
  3. MAXIMUM ALLOWABE BURRS IS 0.076 mm IN ALL DIRECTIONS.
  4. PIN #1 ID ON TOP WILL BE LASER MARKED.

6-Pin 2mm × 2mm MLF® (ML)

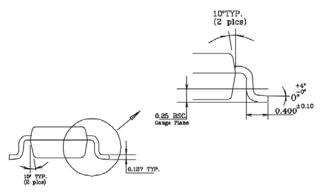
## **Package Information (Continued)**



# OC.00-0.10

#### NOTE:

- Dimensions and tolerances are as per ANSI Y14.5M. 1994.
- Die is facing up for mold. Die is facing down for trim/form, ie. reverse trim/form
- A Dimensions are exclusive of mold flash and gate burr.
  - The footlength measuring is based on the gauge plane method.
  - 5. All specification comply to Jedec Spec M0193 Issue C.
  - 6. All dimensions are in millimeters.



TSOT-23-5 (D5)

#### MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA

TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB http://www.micrel.com

Micrel makes no representations or warranties with respect to the accuracy or completeness of the information furnished in this data sheet. This information is not intended as a warranty and Micrel does not assume responsibility for its use. Micrel reserves the right to change circuitry, specifications and descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Micrel's terms and conditions of sale for such products, Micrel assumes no liability whatsoever, and Micrel disclaims any express or implied warranty relating to the sale and/or use of Micrel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is a Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.

© 2010 Micrel, Incorporated.